

KEMET Part Number: C0603X331G5HACTU
(C0603X331G5HAC7867)



SMD Comm X8R HT150C Flex, Ceramic, 330 pF, 2%, 50 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 0603



Dimensions

Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.15mm
S	0.58mm MIN
B	0.45mm +/-0.15mm

Packaging Specifications

Packaging:	T&R, 180mm, Paper Tape
Packaging Quantity:	4000

General Information

Series:	SMD Comm X8R HT150C Flex
Style:	SMD Chip
Description:	SMD, MLCC, High Temperature, Ultra-Stable
Features:	Ultra-Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	7300 ug
Shelf Life:	78 Weeks
MSL:	1

Specifications

Capacitance:	330 pF
Measurement Condition:	1 MHz 1.0Vrms
Capacitance Tolerance:	2%
Voltage DC:	50 VDC
Dielectric Withstanding Voltage:	125 VDC
Temperature Range:	-55/+150°C
Temperature Coefficient:	X8R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1MHz 1.0Vrms
Dissipation Factor:	2.5% 1 MHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance:	100 GOhms

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